

IN THE CLAIMS

Please take action regarding the claims so that the status is as follows:

1. (Cancelled)
2. (Cancelled)
3. (Cancelled)
4. (Cancelled)
5. (Cancelled)
6. (Cancelled)
7. (Cancelled)
8. (Cancelled)
9. (Cancelled)
10. (Currently Amended) A substrate colored according to the process of claim [[1]] 21.
11. (Cancelled)
12. (Cancelled)
13. (Cancelled)
14. (Cancelled)
15. (Cancelled)
16. (Cancelled)
17. (Cancelled)
18. (Cancelled)
19. (Cancelled)
20. (Cancelled)
21. (New) A process for imparting a simulated patina appearance to a copper substrate comprising the steps of:
selecting a colorant having the desired initial patina color tone; and

producing a noncontinuous layer of said colorant on a surface of the copper substrate to provide the appearance of patination of the desired tone via interspersed spots of said colorant, the remaining portion of said substrate being exposed for natural patination, the step of producing comprising the step of roll coating said noncontinuous colorant layer on said copper substrate surface in a desired pattern.

22. (New) The process of claim 21, wherein the step of roll coating comprises the step of roll coating said noncontinuous layer with an applicator roll having an interrupted surface.

23. (New) The process of claim 21, wherein the step of roll coating comprises the step of roll coating said noncontinuous layer with an applicator roll having discontinuities in its surface.

24. (New) The process of claim 21, further comprising the step of providing an applicator roll, said roll coating step being performed by said applicator roll to provide said noncontinuous colorant layer on said copper substrate surface.

25. (New) The process of claim 24, wherein said applicator roll has an interrupted surface.

26. (New) The process of claim 24, wherein said applicator roll has discontinuities in its surface.

27. (New) The process of claim 24, wherein said applicator roll has a surface, a pattern being established on said roll surface to produce said noncontinuous colorant layer on said copper substrate surface.

28. (New) The process of claim 27, wherein said roll surface pattern is pixel-like.

29. (New) The process of claim 27, wherein said roll surface pattern produces a noncontinuous pixel-like colorant layer on said substrate surface.